



**PU1 thru PU5**

Surface Mount Glass Passivated Superfast Rectifier  
Reverse Voltage 50~600V Forward Current 1A

## **Features**

- Glass passivated superfast recovery Rectifiers
- Low profile, typical thickness 0.8mm
- Low forward voltage drop
- Low leakage current
- Moisture sensitivity: level 1, per J-STD-020
- Heatsink structure
- High temperature soldering guaranteed: 260 °C/10 seconds



RoHS  
COMPLIANT



iSGA  
(SOD-123HS)

## **Typical Applications**

For use of general purpose rectification in lighting, cellular phone, portable device, power supplies and other consumer applications.

### **Maximum Ratings** (TA = 25 °C unless otherwise noted)

Parameter	Symbol	PU1	PU2	PU3	PU4	PU5	Unit
Maximum repetitive peak reverse voltage	VRRM	50	100	200	400	600	V
Maximum RMS voltage	VRMS	35	70	140	280	420	V
Maximum DC blocking voltage	VDC	50	100	200	400	600	V
Maximum average forward rectified current	IF(AV)			1			A
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	IFSM			30			A
Operating junction and storage temperature range	TJ, TSTG			- 55 to + 150			°C

### **Electrical Characteristics** (TA = 25 °C unless otherwise noted)

Parameter	Test Conditions	Symbol	PU1	PU2	PU3	PU4	PU5	Unit
Maximum instantaneous forward voltage	1 A	V <sub>F</sub>		0.95		1.3	1.7	Volts
Maximum DC reverse current at rated DC blocking voltage	TA=25°C TA=125°C	I <sub>R</sub>			5.0 100			µA
Maximum reverse recovery time	I <sub>F</sub> =0.5A, I <sub>R</sub> =1.0A, I <sub>rr</sub> =0.25A	t <sub>rr</sub>			35			nS
Typical junction capacitance	4.0 V, 1 MHz	C <sub>J</sub>			7			pF
Typical thermal resistance <sup>1)</sup>	junction to ambient	R <sub>θJA</sub>			90			°C/W
	junction to case	R <sub>θJC</sub>			25			
	junction to lead	R <sub>θJL</sub>			18			

Note:1)The thermal resistance from junction to ambient,case or lead,mounted on FR-4 P.C.B

## Ratings and Characteristics Curves

(TA = 25°C unless otherwise noted)

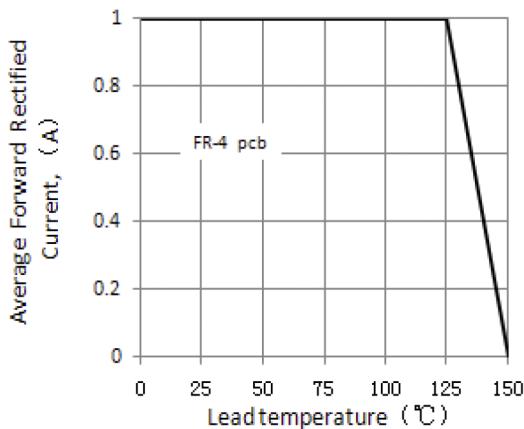


Figure 1. Forward Current Derating Curve

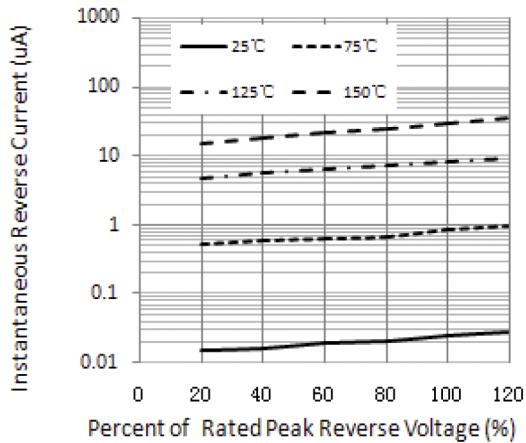


Figure 3. Typical Reverse Characteristics

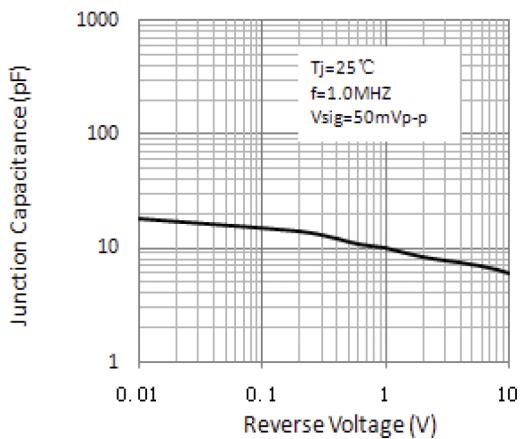


Figure 5. Typical Junction Capacitance

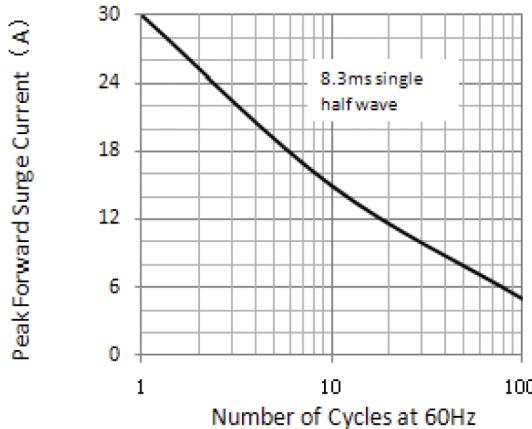


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current

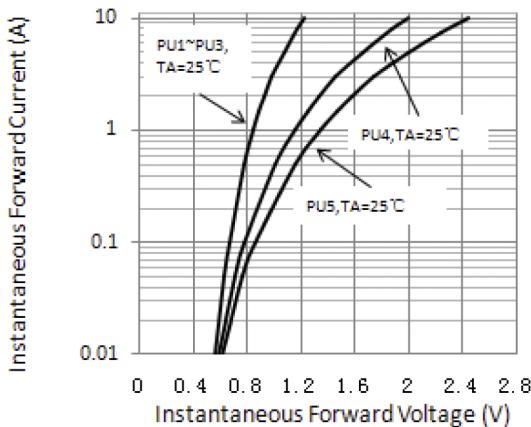


Figure 4. Typical Instantaneous Forward Characteristics

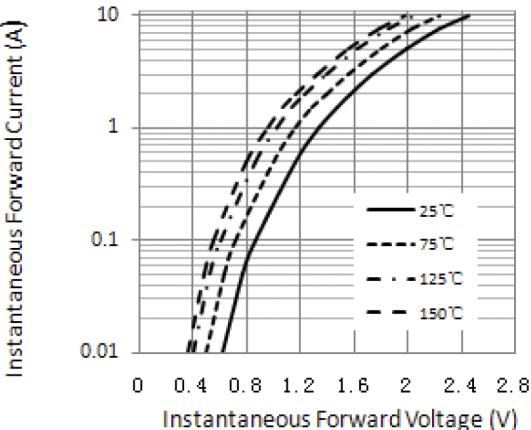
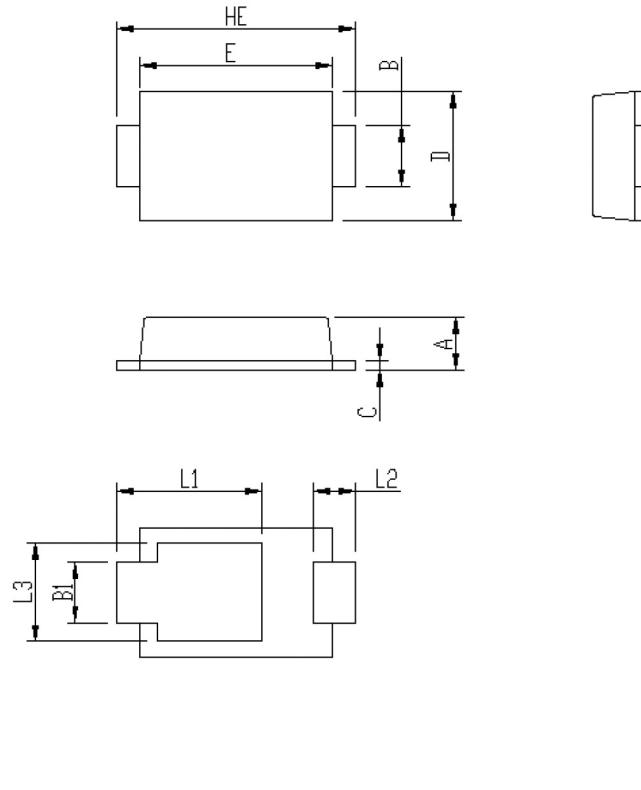


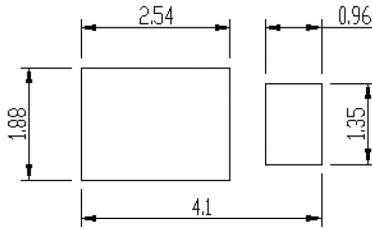
Figure 6. Typical Instantaneous Forward Characteristics (PU5)

## **Package Outline Dimensions**



Package	iSGA	
Unit:mm	MIN	MAX
A	0.75	0.90
B	0.85	1.05
B1	0.85	1.05
C	0.1	0.25
D	1.9	2.1
E	2.9	3.1
L1	2.0	2.45
L2	0.4	0.85
L3	1.3	1.7
HE	3.5	3.9

Soldering footprint



## **Packing Information**

Packing quantities:

Reel size	Quantity/reel	Quantity/inner Box	Quantity/Carton
7"	3K	30K	120K

### Tape & Reel Specification

